INTERNATIONAL STANDARD

IEC 61076-4-113

First edition
2002-11

Connectors for electronic equipment - Printed board connectors –

Part 4-113: Detail specification for two part connectors having 5 rows with a grid of 2,54 mm for printed boards and backplanes in bus applications

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International Electrotechnical Commission
Международная Электротехническая Комиссия

PRICE CODE W

For price, see current catalogue

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FOREWORD

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6) Attention is drawn to the possibility that some of the elements of this International Standard may be the subject of patent rights. The IEC shall not be held responsible for identifying any or all such patent rights.

International Standard IEC 61076-4-113 has been prepared by subcommittee 48B: Connectors, of IEC technical committee 48: Electromechanical components and mechanical structures for electronic equipment.

The text of this standard is based on the following documents:

FDIS	Report on voting
48B/1247/FDIS	48B/1283/RVD

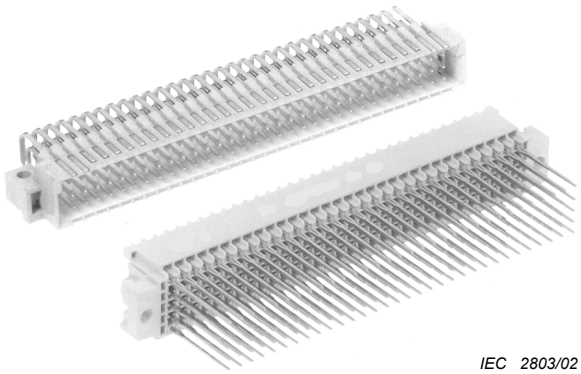
Full information on the voting for the approval of this standard can be found in the report on voting indicated in the above table.

The committee has decided that the contents of this publication will remain unchanged until 2006. At this date, the publication will be

- reconfirmed;
- withdrawn;
- replaced by a revised edition, or
- amended.

CONNECTORS FOR ELECTRONIC EQUIPMENT – PRINTED BOARD CONNECTORS –

Part 4-113: Detail specification for two-part connectors having 5 rows with a grid of 2,54 mm for printed boards and backplanes in bus applications

IEC SC 48B: Connectors Electronic components of assessed quality in accordance with - GENERIC SPECIFICATION IEC 61076-1 Generic specification IEC 61076-1 First edition:1995	**IEC 61076-4-113** Page 5 of 36 pages
See 3 for dimensions  *IEC 2803/02*	Two-part connectors for printed boards and backplanes, grid of 2,54 mm. Connector with 160 contacts in 5 rows. Rows a, b and c in compliance with IEC 60603-2, 3rd edition. Rows z and d with contacts each usable for standard application or for grounding. Termination: Free board connector: Solder connections Fixed board connector: Press-in, wire wrap and interface connections

Reference to IEC Guide 109: Environmental aspects

IEC Guide 109 advocates the need to minimize the impact of a product on the natural environment throughout the product life cycle.

It is understood that some of the materials permitted in this standard and manufacturing and assembly procedures may have a negative environmental impact.

As technological advances lead to acceptable alternatives for these materials, they will be eliminated from the standard. Inappropriate manufacturing procedures should be replaced by a design for easy maintainability and disassembly.

1 General data

1.1 Recommended method of mounting

The contacts of free board connectors are provided for solder connections. The terminations of the free board connectors shall fit into holes in the printed board according to IEC 60326-3 and IEC 60326-5, located on a grid of 2,54 mm.

The contacts of fixed board connectors are provided for either press-in connections or press-in connections with an additional wire wrap and mating function.

The connector is fixed by means of the press-in terminations; fixing holes on the backplane are not necessary.

The distance of termination centre lines is 2,54 mm or a multiple of it. The terminations of the fixed board connectors are suited for backplanes having a grid dimension of 2,54 mm.

1.2 Ratings and characteristics

Rated voltage: Contact / contact for fully loaded connector.

Table 1 – Rated voltage

Material group	Pollution degree	Rated voltage (V)
I, II, IIIa/b	1	400
II, IIIa/b	2	32
NOTE Reference is made to Table 1 of this specification, and to Table 4 of IEC 60664-1 listing the relation between creepage distances, pollution degree and material groups versus voltages r.m.s.		

Current rating: 2 A at 70 °C for fully loaded connector

Insulation resistance: $\geq 10^{10}\ \Omega$

Climatic category: PL1: 55/125/56
PL2: 55/125/21

Printed board thickness: 1,6 mm to 2,4 mm for free board connector
1,6 mm to 6,4 mm for fixed board connector

Contact spacing: 2,54 mm

1.3 Normative references

The following referenced documents are indispensable for the application of this document. For dated references, only the edition cited applies. For undated references, the latest edition of the referenced document (including any amendments) applies.

IEC 60068-1:1988, *Environmental testing – Part 1: General and guidance*
Amendment 1 (1992)

IEC 60068-2-54:1985, *Environmental testing – Part 2: Tests. Test Ta: Soldering – Solderability testing by the wetting balance method*

IEC 60097:1991, *Grid systems for printed circuits*

IEC 60326-3:1991, *Printed boards – Part 3: Design and use of printed boards*

IEC 60326-5:1995, *Printed boards – Part 5: Specification for single and double side printed boards with plated-through holes*

IEC 60352-1:1997, *Solderless connections – Part 1: Wrapped connections – General requirements, test methods and practical guidance*

IEC 60352-5:2001, *Solderless connections – Part 5: Press-in connections – General requirements, test methods and practical guidance*

IEC 60512 (all parts)

IEC 60512-1-100, *Connectors for electronic equipment – Tests and measurements – Part 1-100: Applicable publications*

IEC 60603-2:1995, *Connectors for frequencies below 3 MHz for use with printed boards – Part 2: Detail specification for two-part connectors with assessed quality, for printed boards, for basic grid of 2,54 mm (0,1 in) with common mounting features*

IEC 60664-1:2000, *Insulation coordination for equipment within low-voltage systems – Part 1: Principles, requirements and tests*

IEC 61076-1:1995, *Connectors with assessed quality, for use in d.c. low frequency analogue and in digital high speed data applications – Part 1: Generic specification*

IEC 61076-4:1995, *Connectors with assessed quality, for use in d.c. low frequency analogue and in digital high speed data applications – Part 4: Sectional specification – Printed board connectors*

IEC Guide 109:1995, *Environmental aspects – Inclusion in electrotechnical product standards*

ISO 1302:2002, *Geometrical Product Specifications (GPS) –Indication of surface texture in technical product documentation*